



Reference Specification

150°C Operation Leaded MLCC for Automotive with AEC-Q200
RHE Series

Product specifications in this catalog are as of Dec. 2017, and are subject to change or obsolescence without notice.

Please consult the approval sheet before ordering. Please read rating and Cautions first.

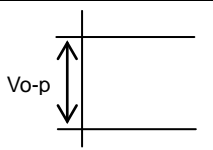
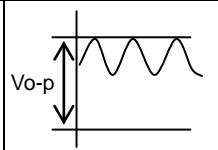
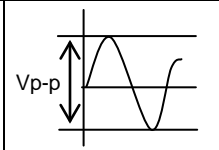
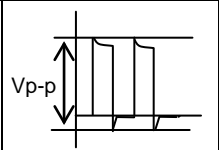
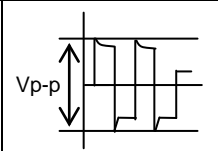
Reference only

⚠ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the V_{p-p} value of the applied voltage or the V_{o-p} which contains DC bias within the rated voltage range. When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.

| Voltage | DC Voltage | DC+AC Voltage | AC Voltage | Pulse Voltage(1) | Pulse Voltage(2) |
|------------------------|---|---|--|---|---|
| Positional Measurement |  |  |  |  |  |

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. In case of Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.), applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C. Please contact us if self-generated heat is occurred with Class 1 capacitors (Temp.Char. : C0G,U2J,X8G, etc.). When measuring, use a thermocouple of small thermal capacity-K of $\phi 0.1\text{mm}$ and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability.

3. Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

4. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 °C and 20 to 70%. Use capacitors within 6 months.

5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

6. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

7. BONDING AND RESIN MOLDING, RESIN COAT

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of a bonded or molded product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

8. TREATMENT AFTER BONDING AND RESIN MOLDING, RESIN COAT

When the outer coating is hot (over 100 °C) after soldering, it becomes soft and fragile.

So please be careful not to give it mechanical stress.

Reference only

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

1. Aircraft equipment
2. Aerospace equipment
3. Undersea equipment
4. Power plant control equipment
5. Medical equipment
6. Transportation equipment (vehicles, trains, ships, etc.)
7. Traffic signal equipment
8. Disaster prevention / crime prevention equipment
9. Data-processing equipment exerting influence on public
10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity : Output of 20 watts per liter or less.

Rinsing time : 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. Soldering and Mounting

Insertion of the Lead Wire

- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.

3. CAPACITANCE CHANGE OF CAPACITORS

- Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.)

Class 2 capacitors an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.



NOTE

1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
2. You are requested not to use our product deviating from this specification.

Reference only

1. Application

This specification is applied to 150°C Operation Leaded MLCC RHE series in accordance with AEC-Q200 requirements used for Automotive Electronic equipment.

2. Rating

- Applied maximum temperature up to 150°C

Note : Maximum accumulative time to 150°C is within 2000 hours.

- Part number configuration

| | | | | | | | | | |
|------|--------|-------------------------------|------------------|-------------|--------------------------|-------------------|--------------|-------------------------------------|--------------------------|
| ex.) | RHE | L8 | 1H | 103 | K | 0 | A2 | H03 | B |
| | Series | Temperature Characteristic | Rated voltage | Capacitance | Capacitance tolerance | Dimension code | Lead code | Individual specification code | Packing style code |

- Series

| Code | Content |
|------|--------------------------|
| RHE | Epoxy coated, 150°C max. |

- Temperature characteristic

| Code | Temp. Char. | Temp. Range | Cap. Change (Within%) | Standard Temp. | Operating Temp. Range |
|------|-------------|-------------|-----------------------|----------------|-----------------------|
| L8 | X8L | -55~+125°C | +/-15 | 25°C | -55~+150°C |
| | | +125~+150°C | +15/-40 | | |

- Rated voltage

| Code | Rated voltage |
|------|---------------|
| 1E | DC25V |
| 1H | DC50V |
| 2A | DC100V |

- Capacitance

The first two digits denote significant figures ; the last digit denotes the multiplier of 10 in pF.
ex.) In case of 103.

$$10 \times 10^3 = 10000 \text{pF}$$

- Capacitance tolerance

| Code | Capacitance tolerance |
|------|-----------------------|
| K | +/-10% |
| M | +/-20% |

- Dimension code

| Code | Dimensions (LxW) mm max. |
|------|--------------------------|
| 0 | 3.6 x 3.5 |
| 1 | 4.0 x 3.5 |
| 2 | 5.5 x 4.0 |
| 3 | 5.5 x 5.0 |
| W | 5.5 x 7.5 |

Reference only

- Lead code

| Code | Lead style | Lead spacing (mm) |
|------|--------------------------|-------------------|
| A2 | Straight type | 2.5+/-0.8 |
| DB | Straight taping type | 2.5+0.4/-0.2 |
| K1 | Inside crimp type | 5.0+/-0.8 |
| M1 | Inside crimp taping type | 5.0+0.6/-0.2 |

Lead wire is solder coated CP wire.

- Individual specification code

Murata's control code

Please refer to [Part number list].

- Packing style code

| Code | Packing style |
|------|---------------------|
| A | Taping type of Ammo |
| B | Bulk type |

3. Marking

Temp. char. : Letter code : 8 (X8L char.)


Capacitance : 3 digit numbers

Capacitance tolerance : Code








Rated voltage : Letter code : 2 (DC25V only, Except dimension code : 0,1)

Letter code : 5 (DC50V only, Except dimension code : 0,1)

Letter code : 1 (DC100V only, Except dimension code : 0,1)

Company name code : Abbreviation :  (Except dimension code : 0,1)

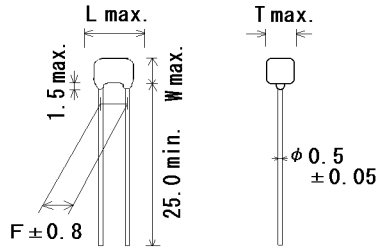
(Ex.)

| Rated voltage Dimension code | 25V | 50V | 100V |
|---------------------------------|---|--|---|
| | 0,1 |  |  |
| 2 |  |  |  |
| 3, W |  |  | — |

Reference only

4. Part number list

• Straight Long
(Lead Code:A2)

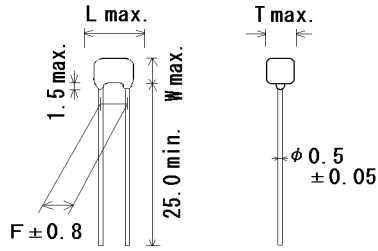


Unit : mm

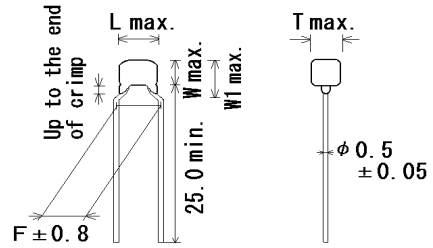
| Customer Part Number | Murata Part Number | T.C. | DC Rated Volt. (V) | Cap. | Cap. tol. | Dimension (mm) | | | | | Size Lead Code | Pack qty. (pcs) |
|----------------------|--------------------|------|--------------------|---------|-----------|----------------|-----|----|-----|------|----------------|-----------------|
| | | | | | | L | W | W1 | F | T | | |
| | RHEL81E104K0A2H03B | X8L | 25 | 0.1μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81E154K0A2H03B | X8L | 25 | 0.15μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81E224K0A2H03B | X8L | 25 | 0.22μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81E334K1A2H03B | X8L | 25 | 0.33μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81E474K1A2H03B | X8L | 25 | 0.47μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81E684K1A2H03B | X8L | 25 | 0.68μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81E105K1A2H03B | X8L | 25 | 1.0μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81E155K2A2H03B | X8L | 25 | 1.5μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81E225K2A2H03B | X8L | 25 | 2.2μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81E335K2A2H03B | X8L | 25 | 3.3μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81E475K2A2H03B | X8L | 25 | 4.7μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81E106K3A2H03B | X8L | 25 | 10μF | ±10% | 5.5 | 5.0 | - | 2.5 | 4.0 | 3A2 | 500 |
| | RHEL81H221K0A2H03B | X8L | 50 | 220pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H331K0A2H03B | X8L | 50 | 330pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H471K0A2H03B | X8L | 50 | 470pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H681K0A2H03B | X8L | 50 | 680pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H102K0A2H03B | X8L | 50 | 1000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H152K0A2H03B | X8L | 50 | 1500pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H222K0A2H03B | X8L | 50 | 2200pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H332K0A2H03B | X8L | 50 | 3300pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H472K0A2H03B | X8L | 50 | 4700pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H682K0A2H03B | X8L | 50 | 6800pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H103K0A2H03B | X8L | 50 | 10000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H153K0A2H03B | X8L | 50 | 15000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H223K0A2H03B | X8L | 50 | 22000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H333K0A2H03B | X8L | 50 | 33000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H473K0A2H03B | X8L | 50 | 47000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H683K0A2H03B | X8L | 50 | 68000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H104K0A2H03B | X8L | 50 | 0.1μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL81H154K1A2H03B | X8L | 50 | 0.15μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81H224K1A2H03B | X8L | 50 | 0.22μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81H334K1A2H03B | X8L | 50 | 0.33μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL81H474K2A2H03B | X8L | 50 | 0.47μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81H684K2A2H03B | X8L | 50 | 0.68μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81H105K2A2H03B | X8L | 50 | 1.0μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81H155K2A2H03B | X8L | 50 | 1.5μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81H225K2A2H03B | X8L | 50 | 2.2μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81H335K3A2H03B | X8L | 50 | 3.3μF | ±10% | 5.5 | 5.0 | - | 2.5 | 4.0 | 3A2 | 500 |
| | RHEL81H475K3A2H03B | X8L | 50 | 4.7μF | ±10% | 5.5 | 5.0 | - | 2.5 | 4.0 | 3A2 | 500 |
| | RHEL82A221K0A2H03B | X8L | 100 | 220pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |

Reference only

• Straight Long
(Lead Code:A2)



• Inside Crimp
(Lead Code:K1)

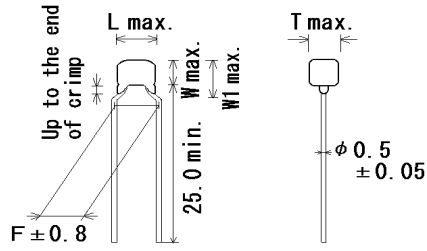


Unit : mm

| Customer Part Number | Murata Part Number | T.C. | DC Rated Volt. (V) | Cap. | Cap. tol. | Dimension (mm) | | | | | Size Lead Code | Pack qty. (pcs) |
|----------------------|--------------------|------|--------------------|---------|-----------|----------------|-----|------|-----|------|----------------|-----------------|
| | | | | | | L | W | W1 | F | T | | |
| | RHEL82A331K0A2H03B | X8L | 100 | 330pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A471K0A2H03B | X8L | 100 | 470pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A681K0A2H03B | X8L | 100 | 680pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A102K0A2H03B | X8L | 100 | 1000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A152K0A2H03B | X8L | 100 | 1500pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A222K0A2H03B | X8L | 100 | 2200pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A332K0A2H03B | X8L | 100 | 3300pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A472K0A2H03B | X8L | 100 | 4700pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A682K0A2H03B | X8L | 100 | 6800pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A103K0A2H03B | X8L | 100 | 10000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A153K0A2H03B | X8L | 100 | 15000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A223K0A2H03B | X8L | 100 | 22000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 0A2 | 500 |
| | RHEL82A333K1A2H03B | X8L | 100 | 33000pF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL82A473K1A2H03B | X8L | 100 | 47000pF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL82A683K1A2H03B | X8L | 100 | 68000pF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL82A104K1A2H03B | X8L | 100 | 0.1μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 1A2 | 500 |
| | RHEL82A154K2A2H03B | X8L | 100 | 0.15μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL82A224K2A2H03B | X8L | 100 | 0.22μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 2A2 | 500 |
| | RHEL81E104K0K1H03B | X8L | 25 | 0.1μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81E154K0K1H03B | X8L | 25 | 0.15μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81E224K0K1H03B | X8L | 25 | 0.22μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81E334K1K1H03B | X8L | 25 | 0.33μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81E474K1K1H03B | X8L | 25 | 0.47μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81E684K1K1H03B | X8L | 25 | 0.68μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81E105K1K1H03B | X8L | 25 | 1.0μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81E155K2K1H03B | X8L | 25 | 1.5μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81E225K2K1H03B | X8L | 25 | 2.2μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81E335K2K1H03B | X8L | 25 | 3.3μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81E475K2K1H03B | X8L | 25 | 4.7μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81E106K3K1H03B | X8L | 25 | 10μF | ±10% | 5.5 | 5.0 | 7.5 | 5.0 | 4.0 | 3K1 | 500 |
| | RHEL81E226MWK1H03B | X8L | 25 | 22μF | ±20% | 5.5 | 7.5 | 10.0 | 5.0 | 4.0 | WK1 | 500 |
| | RHEL81H221K0K1H03B | X8L | 50 | 220pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H331K0K1H03B | X8L | 50 | 330pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H471K0K1H03B | X8L | 50 | 470pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H681K0K1H03B | X8L | 50 | 680pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H102K0K1H03B | X8L | 50 | 1000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H152K0K1H03B | X8L | 50 | 1500pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H222K0K1H03B | X8L | 50 | 2200pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H332K0K1H03B | X8L | 50 | 3300pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H472K0K1H03B | X8L | 50 | 4700pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |

Reference only

- Inside Crimp
(Lead Code:K1)

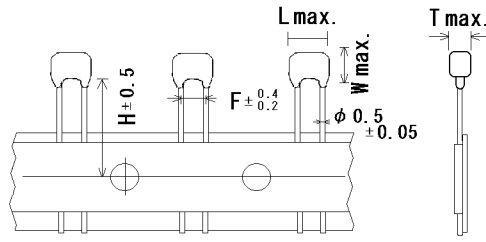


Unit : mm

| Customer Part Number | Murata Part Number | T.C. | DC Rated Volt. (V) | Cap. | Cap. tol. | Dimension (mm) | | | | | Size Lead Code | Pack qty. (pcs) |
|----------------------|--------------------|------|--------------------|---------|-----------|----------------|-----|------|-----|------|----------------|-----------------|
| | | | | | | L | W | W1 | F | T | | |
| | RHEL81H682K0K1H03B | X8L | 50 | 6800pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H103K0K1H03B | X8L | 50 | 10000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H153K0K1H03B | X8L | 50 | 15000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H223K0K1H03B | X8L | 50 | 22000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H333K0K1H03B | X8L | 50 | 33000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H473K0K1H03B | X8L | 50 | 47000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H683K0K1H03B | X8L | 50 | 68000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H104K0K1H03B | X8L | 50 | 0.1μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL81H154K1K1H03B | X8L | 50 | 0.15μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81H224K1K1H03B | X8L | 50 | 0.22μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81H334K1K1H03B | X8L | 50 | 0.33μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL81H474K2K1H03B | X8L | 50 | 0.47μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81H684K2K1H03B | X8L | 50 | 0.68μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81H105K2K1H03B | X8L | 50 | 1.0μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81H155K2K1H03B | X8L | 50 | 1.5μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81H225K2K1H03B | X8L | 50 | 2.2μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL81H335K3K1H03B | X8L | 50 | 3.3μF | ±10% | 5.5 | 5.0 | 7.5 | 5.0 | 4.0 | 3K1 | 500 |
| | RHEL81H475K3K1H03B | X8L | 50 | 4.7μF | ±10% | 5.5 | 5.0 | 7.5 | 5.0 | 4.0 | 3K1 | 500 |
| | RHEL81H106MVK1H03B | X8L | 50 | 10μF | ±20% | 5.5 | 7.5 | 10.0 | 5.0 | 4.0 | WK1 | 500 |
| | RHEL82A221K0K1H03B | X8L | 100 | 220pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A331K0K1H03B | X8L | 100 | 330pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A471K0K1H03B | X8L | 100 | 470pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A681K0K1H03B | X8L | 100 | 680pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A102K0K1H03B | X8L | 100 | 1000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A152K0K1H03B | X8L | 100 | 1500pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A222K0K1H03B | X8L | 100 | 2200pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A332K0K1H03B | X8L | 100 | 3300pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A472K0K1H03B | X8L | 100 | 4700pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A682K0K1H03B | X8L | 100 | 6800pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A103K0K1H03B | X8L | 100 | 10000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A153K0K1H03B | X8L | 100 | 15000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A223K0K1H03B | X8L | 100 | 22000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 0K1 | 500 |
| | RHEL82A333K1K1H03B | X8L | 100 | 33000pF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL82A473K1K1H03B | X8L | 100 | 47000pF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL82A683K1K1H03B | X8L | 100 | 68000pF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL82A104K1K1H03B | X8L | 100 | 0.1μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 1K1 | 500 |
| | RHEL82A154K2K1H03B | X8L | 100 | 0.15μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |
| | RHEL82A224K2K1H03B | X8L | 100 | 0.22μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 2K1 | 500 |

Reference only

- Straight Taping
(Lead Code:DB)

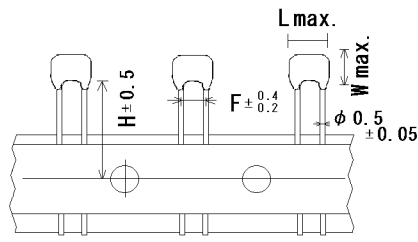


Unit : mm

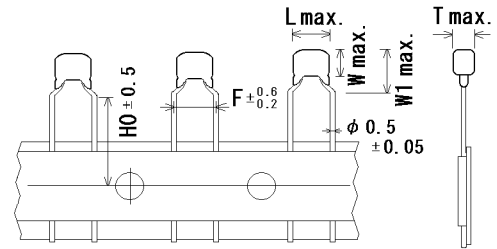
| Customer Part Number | Murata Part Number | T.C. | DC Rated volt. (V) | Cap. | Cap. tol. | Dimension (mm) | | | | | | Size Lead Code | Pack qty. (pcs) |
|----------------------|--------------------|------|--------------------|---------|-----------|----------------|-----|----|-----|------|------|----------------|-----------------|
| | | | | | | L | W | W1 | F | T | H0 | | |
| | RHEL81E104K0DBH03A | X8L | 25 | 0.1μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81E154K0DBH03A | X8L | 25 | 0.15μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81E224K0DBH03A | X8L | 25 | 0.22μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81E334K1DBH03A | X8L | 25 | 0.33μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81E474K1DBH03A | X8L | 25 | 0.47μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81E684K1DBH03A | X8L | 25 | 0.68μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81E105K1DBH03A | X8L | 25 | 1.0μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81E155K2DBH03A | X8L | 25 | 1.5μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81E225K2DBH03A | X8L | 25 | 2.2μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81E335K2DBH03A | X8L | 25 | 3.3μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81E475K2DBH03A | X8L | 25 | 4.7μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81E106K3DBH03A | X8L | 25 | 10μF | ±10% | 5.5 | 5.0 | - | 2.5 | 4.0 | 16.0 | 3DB | 1500 |
| | RHEL81H221K0DBH03A | X8L | 50 | 220pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H331K0DBH03A | X8L | 50 | 330pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H471K0DBH03A | X8L | 50 | 470pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H681K0DBH03A | X8L | 50 | 680pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H102K0DBH03A | X8L | 50 | 1000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H152K0DBH03A | X8L | 50 | 1500pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H222K0DBH03A | X8L | 50 | 2200pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H332K0DBH03A | X8L | 50 | 3300pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H472K0DBH03A | X8L | 50 | 4700pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H682K0DBH03A | X8L | 50 | 6800pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H103K0DBH03A | X8L | 50 | 10000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H153K0DBH03A | X8L | 50 | 15000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H223K0DBH03A | X8L | 50 | 22000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H333K0DBH03A | X8L | 50 | 33000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H473K0DBH03A | X8L | 50 | 47000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H683K0DBH03A | X8L | 50 | 68000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H104K0DBH03A | X8L | 50 | 0.1μF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL81H154K1DBH03A | X8L | 50 | 0.15μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81H224K1DBH03A | X8L | 50 | 0.22μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81H334K1DBH03A | X8L | 50 | 0.33μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL81H474K2DBH03A | X8L | 50 | 0.47μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81H684K2DBH03A | X8L | 50 | 0.68μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81H105K2DBH03A | X8L | 50 | 1.0μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81H155K2DBH03A | X8L | 50 | 1.5μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81H225K2DBH03A | X8L | 50 | 2.2μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81H335K3DBH03A | X8L | 50 | 3.3μF | ±10% | 5.5 | 5.0 | - | 2.5 | 4.0 | 16.0 | 3DB | 2000 |
| | RHEL81H475K3DBH03A | X8L | 50 | 4.7μF | ±10% | 5.5 | 5.0 | - | 2.5 | 4.0 | 16.0 | 3DB | 2000 |
| | RHEL82A221K0DBH03A | X8L | 100 | 220pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |

Reference only

• Straight Taping
(Lead Code: DB)



• Inside Crimp Taping
(Lead Code: M*)

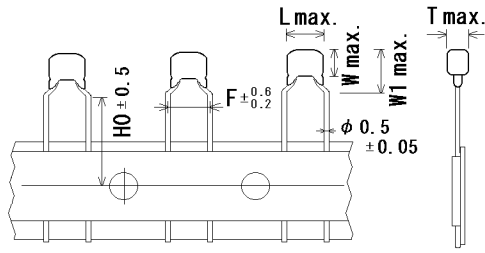


Unit : mm

| Customer Part Number | Murata Part Number | T.C. | DC Rated volt. (V) | Cap. | Cap. tol. | Dimension (mm) | | | | | | Size Lead Code | Pack qty. (pcs) |
|----------------------|--------------------|------|--------------------|---------|-----------|----------------|-----|------|-----|------|------|----------------|-----------------|
| | | | | | | L | W | W1 | F | T | H0 | | |
| | RHEL82A331K0DBH03A | X8L | 100 | 330pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A471K0DBH03A | X8L | 100 | 470pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A681K0DBH03A | X8L | 100 | 680pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A102K0DBH03A | X8L | 100 | 1000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A152K0DBH03A | X8L | 100 | 1500pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A222K0DBH03A | X8L | 100 | 2200pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A332K0DBH03A | X8L | 100 | 3300pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A472K0DBH03A | X8L | 100 | 4700pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A682K0DBH03A | X8L | 100 | 6800pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A103K0DBH03A | X8L | 100 | 10000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A153K0DBH03A | X8L | 100 | 15000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A223K0DBH03A | X8L | 100 | 22000pF | ±10% | 3.6 | 3.5 | - | 2.5 | 2.5 | 16.0 | 0DB | 2000 |
| | RHEL82A333K1DBH03A | X8L | 100 | 33000pF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL82A473K1DBH03A | X8L | 100 | 47000pF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL82A683K1DBH03A | X8L | 100 | 68000pF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL82A104K1DBH03A | X8L | 100 | 0.1μF | ±10% | 4.0 | 3.5 | - | 2.5 | 2.5 | 16.0 | 1DB | 2000 |
| | RHEL82A154K2DBH03A | X8L | 100 | 0.15μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL82A224K2DBH03A | X8L | 100 | 0.22μF | ±10% | 5.5 | 4.0 | - | 2.5 | 3.15 | 16.0 | 2DB | 2000 |
| | RHEL81E104K0M1H03A | X8L | 25 | 0.1μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81E154K0M1H03A | X8L | 25 | 0.15μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81E224K0M1H03A | X8L | 25 | 0.22μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81E334K1M1H03A | X8L | 25 | 0.33μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81E474K1M1H03A | X8L | 25 | 0.47μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81E684K1M1H03A | X8L | 25 | 0.68μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81E105K1M1H03A | X8L | 25 | 1.0μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81E155K2M1H03A | X8L | 25 | 1.5μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81E225K2M1H03A | X8L | 25 | 2.2μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81E335K2M1H03A | X8L | 25 | 3.3μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81E475K2M1H03A | X8L | 25 | 4.7μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81E106K3M1H03A | X8L | 25 | 10μF | ±10% | 5.5 | 5.0 | 7.5 | 5.0 | 4.0 | 16.0 | 3M1 | 1500 |
| | RHEL81E226MWM1H03A | X8L | 25 | 22μF | ±20% | 5.5 | 7.5 | 10.0 | 5.0 | 4.0 | 16.0 | WM1 | 1500 |
| | RHEL81H221K0M1H03A | X8L | 50 | 220pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H331K0M1H03A | X8L | 50 | 330pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H471K0M1H03A | X8L | 50 | 470pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H681K0M1H03A | X8L | 50 | 680pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H102K0M1H03A | X8L | 50 | 1000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H152K0M1H03A | X8L | 50 | 1500pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H222K0M1H03A | X8L | 50 | 2200pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H332K0M1H03A | X8L | 50 | 3300pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H472K0M1H03A | X8L | 50 | 4700pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |

Reference only

• Inside Crimp Taping
(Lead Code: M*)



Unit : mm

| Customer Part Number | Murata Part Number | T.C. | DC Rated volt. (V) | Cap. | Cap. tol. | Dimension (mm) | | | | | | Size Lead Code | Pack qty. (pcs) |
|----------------------|--------------------|------|--------------------|---------|-----------|----------------|-----|------|-----|------|------|----------------|-----------------|
| | | | | | | L | W | W1 | F | T | H0 | | |
| | RHEL81H682K0M1H03A | X8L | 50 | 6800pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H103K0M1H03A | X8L | 50 | 10000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H153K0M1H03A | X8L | 50 | 15000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H223K0M1H03A | X8L | 50 | 22000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H333K0M1H03A | X8L | 50 | 33000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H473K0M1H03A | X8L | 50 | 47000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H683K0M1H03A | X8L | 50 | 68000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H104K0M1H03A | X8L | 50 | 0.1μF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL81H154K1M1H03A | X8L | 50 | 0.15μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81H224K1M1H03A | X8L | 50 | 0.22μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81H334K1M1H03A | X8L | 50 | 0.33μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL81H474K2M1H03A | X8L | 50 | 0.47μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81H684K2M1H03A | X8L | 50 | 0.68μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81H105K2M1H03A | X8L | 50 | 1.0μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81H155K2M1H03A | X8L | 50 | 1.5μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81H225K2M1H03A | X8L | 50 | 2.2μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL81H335K3M1H03A | X8L | 50 | 3.3μF | ±10% | 5.5 | 5.0 | 7.5 | 5.0 | 4.0 | 16.0 | 3M1 | 1500 |
| | RHEL81H475K3M1H03A | X8L | 50 | 4.7μF | ±10% | 5.5 | 5.0 | 7.5 | 5.0 | 4.0 | 16.0 | 3M1 | 1500 |
| | RHEL81H106MWM1H03A | X8L | 50 | 10μF | ±20% | 5.5 | 7.5 | 10.0 | 5.0 | 4.0 | 16.0 | WM1 | 1500 |
| | RHEL82A221K0M1H03A | X8L | 100 | 220pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A331K0M1H03A | X8L | 100 | 330pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A471K0M1H03A | X8L | 100 | 470pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A681K0M1H03A | X8L | 100 | 680pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A102K0M1H03A | X8L | 100 | 1000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A152K0M1H03A | X8L | 100 | 1500pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A222K0M1H03A | X8L | 100 | 2200pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A332K0M1H03A | X8L | 100 | 3300pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A472K0M1H03A | X8L | 100 | 4700pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A682K0M1H03A | X8L | 100 | 6800pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A103K0M1H03A | X8L | 100 | 10000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A153K0M1H03A | X8L | 100 | 15000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A223K0M1H03A | X8L | 100 | 22000pF | ±10% | 3.6 | 3.5 | 6.0 | 5.0 | 2.5 | 16.0 | 0M1 | 2000 |
| | RHEL82A333K1M1H03A | X8L | 100 | 33000pF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL82A473K1M1H03A | X8L | 100 | 47000pF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL82A683K1M1H03A | X8L | 100 | 68000pF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL82A104K1M1H03A | X8L | 100 | 0.1μF | ±10% | 4.0 | 3.5 | 5.0 | 5.0 | 2.5 | 16.0 | 1M1 | 2000 |
| | RHEL82A154K2M1H03A | X8L | 100 | 0.15μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |
| | RHEL82A224K2M1H03A | X8L | 100 | 0.22μF | ±10% | 5.5 | 4.0 | 6.0 | 5.0 | 3.15 | 16.0 | 2M1 | 2000 |

Reference only

| 5. AEC-Q200 Murata Standard Specifications and Test Methods | | | | |
|---|-------------------------------------|---------------------------------|---|------------|
| No. | AEC-Q200 Test Item | Specification | AEC-Q200 Test Method | |
| 1 | Pre-and Post-Stress Electrical Test | | - | |
| 2 | High Temperature Exposure (Storage) | Appearance | No defects or abnormalities | |
| | | Capacitance Change | within $\pm 12.5\%$ | |
| | | D.F. | 0.04 max. | |
| | | I.R. | More than 1,000M Ω or 50 M Ω - μ F (Whichever is smaller) | |
| 3 | Temperature Cycling | Appearance | No defects or abnormalities except color change of outer coating. | |
| | | Capacitance Change | within $\pm 12.5\%$ | |
| | | D.F. | 0.05 max. | |
| | | I.R. | 1,000M Ω or 50M Ω - μ F min. (Whichever is smaller) | |
| Step | 1 | 2 | 3 | 4 |
| Temp. ($^{\circ}$ C) | -55+0/-3 | Room Temp. | 150+3/-0 | Room Temp. |
| Time (min.) | 15 \pm 3 | 1 | 15 \pm 3 | 1 |
| 4 | Moisture Resistance | Appearance | No defects or abnormalities | |
| | | Capacitance Change | within $\pm 12.5\%$ | |
| | | D.F. | 0.05 max. | |
| | | I.R. | 500M Ω or 25M Ω - μ F min. (Whichever is smaller) | |
| 5 | Biased Humidity | Appearance | No defects or abnormalities | |
| | | Capacitance Change | within $\pm 12.5\%$ | |
| | | D.F. | 0.05 max. | |
| | | I.R. | 500M Ω or 25M Ω - μ F min. (Whichever is smaller) | |
| 6 | Operational Life | Appearance | No defects or abnormalities except color change of outer coating. | |
| | | Capacitance Change | within $\pm 12.5\%$ | |
| | | D.F. | 0.04 max. | |
| | | I.R. | 1,000M Ω or 50M Ω - μ F min. (Whichever is smaller) | |
| 7 | External Visual | No defects or abnormalities | Visual inspection | |
| 8 | Physical Dimension | Within the specified dimensions | Using calipers and micrometers. | |
| 9 | Marking | To be easily legible. | Visual inspection | |
| 10 | Resistance to Solvents | Appearance | No defects or abnormalities | |
| | | Capacitance | Within the specified tolerance | |
| | | D.F. | 0.025 max. | |
| | | I.R. | More than 10,000M Ω or 500 M Ω - μ F (Whichever is smaller) | |

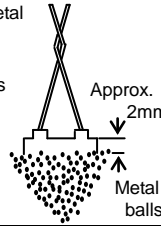
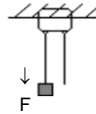
* "room condition" Temperature:15 to 35 $^{\circ}$ C, Relative humidity:45 to 75%, Atmosphere pressure:86 to 106kPa

Reference only

| No. | AEC-Q200 Test Item | Specification | AEC-Q200 Test Method |
|------|--|---|---|
| 11 | Mechanical Shock | Appearance | No defects or abnormalities |
| | | Capacitance | Within the specified tolerance |
| | | D.F. | 0.025 max. |
| 12 | Vibration | Appearance | No defects or abnormalities |
| | | Capacitance | Within the specified tolerance |
| | | D.F. | 0.025 max. |
| 13-1 | Resistance to Soldering Heat (Non-Preheat) | Appearance | No defects or abnormalities |
| | | Capacitance Change | Within $\pm 7.5\%$ |
| | | Dielectric Strength (Between terminals) | No defects |
| 13-2 | Resistance to Soldering Heat (On-Preheat) | Appearance | No defects or abnormalities |
| | | Capacitance Change | Within $\pm 7.5\%$ |
| | | Dielectric Strength (Between terminals) | No defects |
| 13-3 | Resistance to Soldering Heat (soldering iron method) | Appearance | No defects or abnormalities |
| | | Capacitance Change | Within $\pm 7.5\%$ |
| | | Dielectric Strength (Between terminals) | No defects |
| 14 | Thermal Shock | Appearance | No defects or abnormalities |
| | | Capacitance Change | within $\pm 12.5\%$ |
| | | D.F. | 0.05 max. |
| | | I.R. | 1,000M Ω or 50M Ω · μ F min. (Whichever is smaller) |
| 15 | ESD | Appearance | No defects or abnormalities |
| | | Capacitance | Within the specified tolerance |
| | | D.F. | 0.025 max. |
| | | I.R. | More than 10,000M Ω or 500 M Ω · μ F (Whichever is smaller) |
| 16 | Solderability | Lead wire should be soldered with uniform coating on the axial direction over 95% of the circumferential direction. | <p>The terminal of a capacitor is dipped into a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion) and then into molten solder (JIS-Z-3282) for 2\pm0.5 sec. In both cases the depth of dipping is up to about 1.5 to 2mm from the terminal body.</p> <p>Temp. of solder : 245\pm5°C Lead Free Solder(Sn-3.0Ag-0.5Cu) 235\pm5°C H60A or H63A Eutectic Solder</p> |

* "room condition" Temperature:15 to 35°C, Relative humidity:45 to 75%, Atmosphere pressure:86 to 106kPa

Reference only

| No. | AEC-Q200 Test Item | Specifications | AEC-Q200 Test Method | | | | | | | | | | | | |
|--|---|---|---|---|-----------------|---------|----------|-------------|-------|---|------|---|-------|---|------|
| 17 | Electrical Characterization | Appearance | No defects or abnormalities | Visual inspection. | | | | | | | | | | | |
| | | Capacitance | Within the specified tolerance | The capacitance/D.F. should be measured at 25°C at the frequency and voltage shown in the table. <table border="1" style="margin: 10px auto; border-collapse: collapse;"> <thead> <tr> <th style="width: 50%;">Frequency</th> <th style="width: 50%;">Voltage</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">1±0.1kHz</td> <td style="text-align: center;">1±0.2V(rms)</td> </tr> </tbody> </table> | Frequency | Voltage | 1±0.1kHz | 1±0.2V(rms) | | | | | | | |
| | | Frequency | Voltage | | | | | | | | | | | | |
| | | 1±0.1kHz | 1±0.2V(rms) | | | | | | | | | | | | |
| | | D.F. | 0.025 max. | | | | | | | | | | | | |
| Insulation Resistance (I.R.) | Room Temperature | 10,000MΩ or 500MΩ·μF min. (Whichever is smaller) | The insulation resistance should be measured at 25±3 °C with a DC voltage not exceeding the rated voltage at normal temperature and humidity and within 2 min. of charging. (Charge/Discharge current ≤ 50mA) | | | | | | | | | | | | |
| | High Temperature | 100MΩ or 5MΩ·μF min. (Whichever is smaller) | The insulation resistance should be measured at 150±3 °C with a DC voltage not exceeding the rated voltage at normal temperature and humidity and within 2 min. of charging. (Charge/Discharge current ≤ 50mA) | | | | | | | | | | | | |
| Dielectric Strength | Between Terminals | No defects or abnormalities | The capacitor should not be damaged when DC voltage of 250% of the rated voltage is applied between the terminations for 1 to 5 seconds. (Charge/Discharge current ≤ 50mA.) | | | | | | | | | | | | |
| | Body Insulation | No defects or abnormalities | The capacitor is placed in a container with metal balls of 1mm diameter so that each terminal, short-circuit is kept approximately 2mm from the balls, and 250% of the rated DC voltage is impressed for 1 to 5 seconds between capacitor terminals and metal balls. (Charge/Discharge current ≤ 50mA.) <div style="text-align: right; margin-top: 10px;">  <p style="margin: 0;">Approx. 2mm Metal balls</p> </div> | | | | | | | | | | | | |
| 18 | Terminal Strength | Tensile Strength | Termination not to be broken or loosened | As in the figure, fix the capacitor body, apply the force gradually to each lead in the radial direction of the capacitor until reaching 10N and then keep the force applied for 10±1 seconds. <div style="text-align: center; margin-top: 10px;">  </div> | | | | | | | | | | | |
| | | Bending Strength | Termination not to be broken or loosened | Each lead wire should be subjected to a force of 2.5N and then be bent 90° at the point of egress in one direction. Each wire is then returned to the original position and bent 90° in the opposite direction at the rate of one bend per 2 to 3 seconds. | | | | | | | | | | | |
| 19 | Capacitance Temperature Characteristics | Within the specified Tolerance. -55 to 125°C : within ±15% 125 to 150°C : within +15/-40% | The capacitance change should be measured after 5min. at each specified temperature step. <table border="1" style="margin: 10px auto; border-collapse: collapse;"> <thead> <tr> <th style="width: 20%;">Step</th> <th style="width: 80%;">Temperature(°C)</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">1</td> <td style="text-align: center;">25±2</td> </tr> <tr> <td style="text-align: center;">2</td> <td style="text-align: center;">-55±3</td> </tr> <tr> <td style="text-align: center;">3</td> <td style="text-align: center;">25±2</td> </tr> <tr> <td style="text-align: center;">4</td> <td style="text-align: center;">150±3</td> </tr> <tr> <td style="text-align: center;">5</td> <td style="text-align: center;">25±2</td> </tr> </tbody> </table> <p>The ranges of capacitance change compared with the above 25°C value over the temperature ranges shown in the table should be within the specified ranges.</p> <p>•Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min and then let sit for 24±2 h at *room condition. Perform the initial measurement.</p> | Step | Temperature(°C) | 1 | 25±2 | 2 | -55±3 | 3 | 25±2 | 4 | 150±3 | 5 | 25±2 |
| Step | Temperature(°C) | | | | | | | | | | | | | | |
| 1 | 25±2 | | | | | | | | | | | | | | |
| 2 | -55±3 | | | | | | | | | | | | | | |
| 3 | 25±2 | | | | | | | | | | | | | | |
| 4 | 150±3 | | | | | | | | | | | | | | |
| 5 | 25±2 | | | | | | | | | | | | | | |
| * "room condition" Temperature:15 to 35°C, Relative humidity:45 to 75%, Atmosphere pressure:86 to 106kPa | | | | | | | | | | | | | | | |

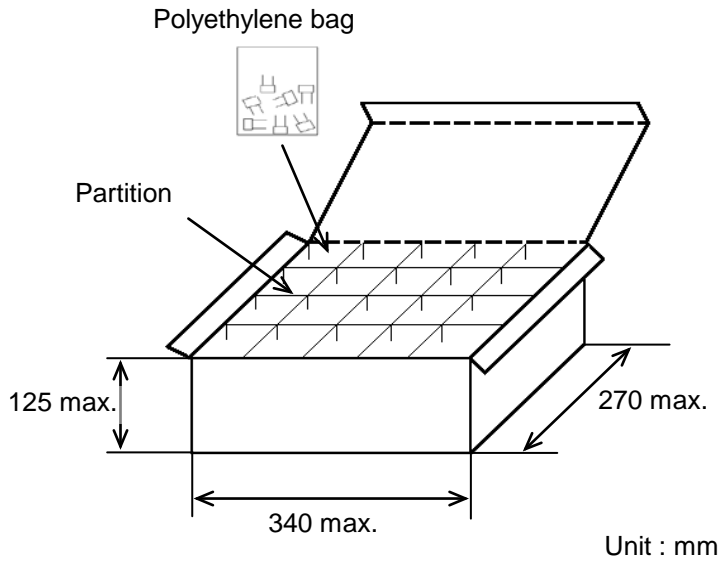
Reference only

6. Packing specification

- Bulk type (Packing style code : B)

The number of packing = $\frac{\text{Packing quantity}}{n} \times n$

The size of packing case and packing way



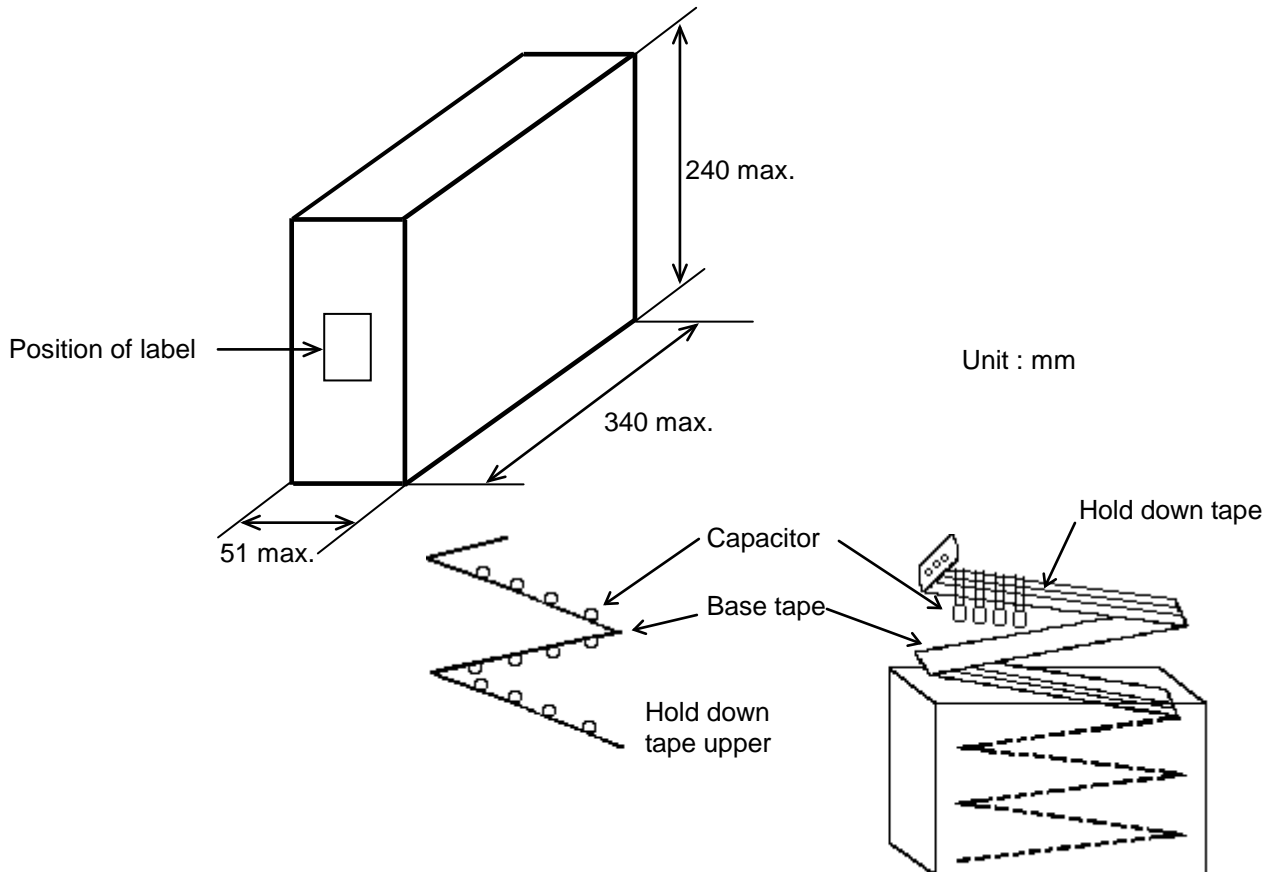
- *1 : Please refer to [Part number list].
- *2 : Standard n = 20 (bag)

Note)
The outer package and the number of outer packing be changed by the order getting amount.

- Ammo pack taping type (Packing style code : A)

- A crease is made every 25 pitches, and the tape with capacitors is packed zigzag into a case.
- When body of the capacitor is piled on other body under it.

The size of packing case and packing way



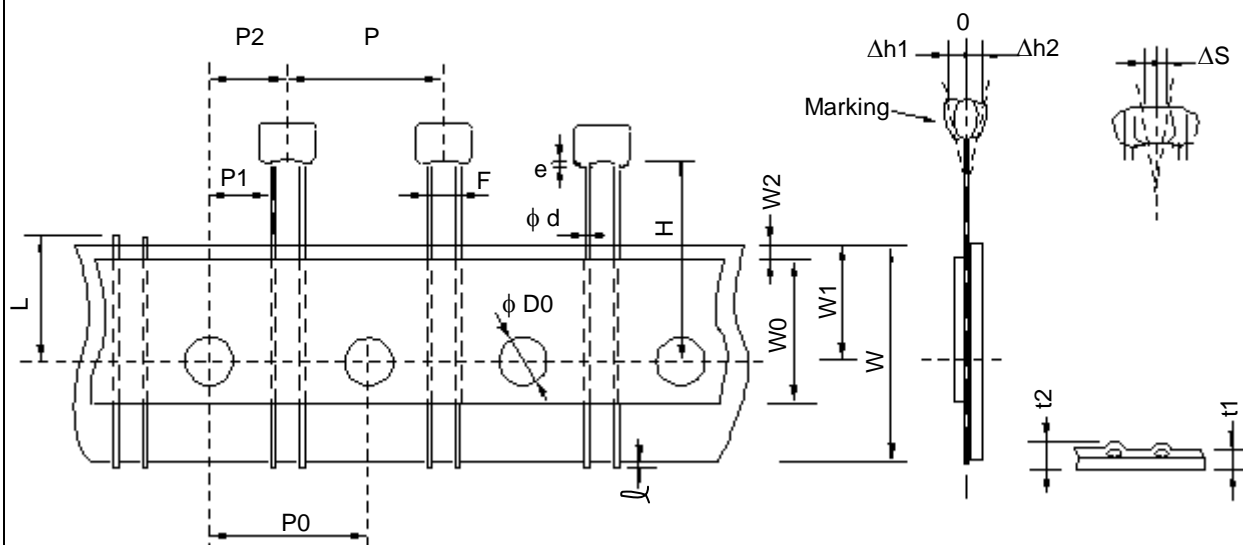
Reference only

7. Taping specification

7-1. Dimension of capacitors on tape

Straight taping type < Lead code : DB >

Pitch of component 12.7mm / Lead spacing 2.5mm

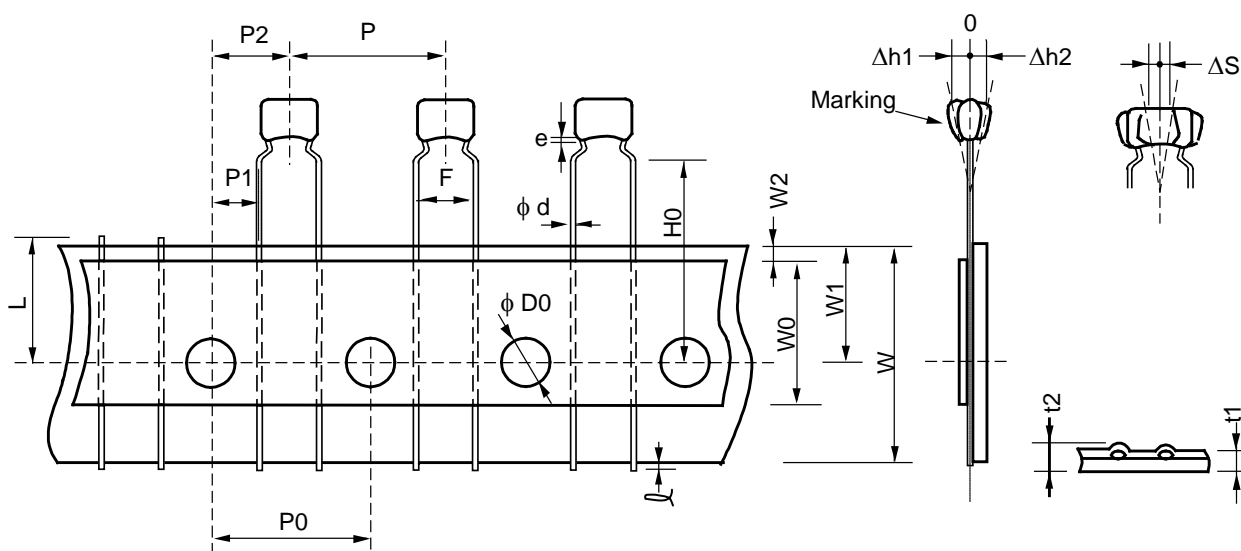


Unit : mm

| Item | Code | Dimensions | Remarks |
|--|-------------|--------------|--|
| Pitch of component | P | 12.7+/-1.0 | |
| Pitch of sprocket hole | P0 | 12.7+/-0.2 | |
| Lead spacing | F | 2.5+0.4/-0.2 | |
| Length from hole center to component center | P2 | 6.35+/-1.3 | Deviation of progress direction |
| Length from hole center to lead | P1 | 5.1+/-0.7 | |
| Deviation along tape, left or right defect | ΔS | 0+/-2.0 | They include deviation by lead bend . |
| Carrier tape width | W | 18.0+/-0.5 | |
| Position of sprocket hole | W1 | 9.0+0/-0.5 | Deviation of tape width direction |
| Lead distance between reference and bottom plane | H | 16.0+/-0.5 | |
| Protrusion length | l | 0.5 max. | |
| Diameter of sprocket hole | D0 | 4.0+/-0.1 | |
| Lead diameter | d | 0.50+/-0.05 | |
| Total tape thickness | t1 | 0.6+/-0.3 | They include hold down tape thickness. |
| Total thickness of tape and lead wire | t2 | 1.5 max. | |
| Deviation across tape | $\Delta h1$ | 1.0 max. | |
| | $\Delta h2$ | | |
| Portion to cut in case of defect | L | 11.0+0/-1.0 | |
| Hold down tape width | W0 | 9.5 min. | |
| Hold down tape position | W2 | 1.5+/-1.5 | |
| Coating extension on lead | e | 1.5 max. | |

Reference only

Inside crimp tapping type < Lead code : M1 >
Pitch of component 12.7mm / Lead spacing 5.0mm



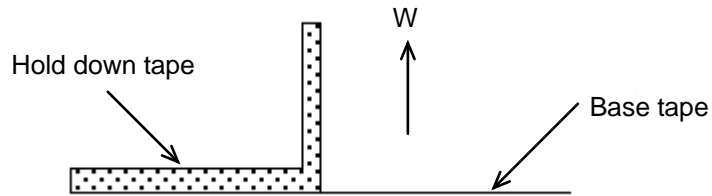
Unit : mm

| Item | Code | Dimensions | Remarks |
|--|------|-------------------------------|--|
| Pitch of component | P | 12.7+/-1.0 | |
| Pitch of sprocket hole | P0 | 12.7+/-0.2 | |
| Lead spacing | F | 5.0+0.6/-0.2 | |
| Length from hole center to component center | P2 | 6.35+/-1.3 | Deviation of progress direction |
| Length from hole center to lead | P1 | 3.85+/-0.7 | |
| Deviation along tape, left or right defect | ΔS | 0+/-2.0 | They include deviation by lead bend . |
| Carrier tape width | W | 18.0+/-0.5 | |
| Position of sprocket hole | W1 | 9.0+0/-0.5 | Deviation of tape width direction |
| Lead distance between reference and bottom plane | H0 | 16.0+/-0.5 | |
| Protrusion length | ℓ | 0.5 max. | |
| Diameter of sprocket hole | D0 | 4.0+/-0.1 | |
| Lead diameter | φd | 0.50+/-0.05 | |
| Total tape thickness | t1 | 0.6+/-0.3 | They include hold down tape thickness. |
| Total thickness of tape and lead wire | t2 | 1.5 max. | |
| Deviation across tape | Δh1 | 2.0 max. (Dimension code : W) | |
| | Δh2 | 1.0 max. (except as above) | |
| Portion to cut in case of defect | L | 11.0+0/-1.0 | |
| Hold down tape width | W0 | 9.5 min. | |
| Hold down tape position | W2 | 1.5+/-1.5 | |
| Coating extension on lead | e | Up to the end of crimp | |

Reference only

7-2. Splicing way of tape

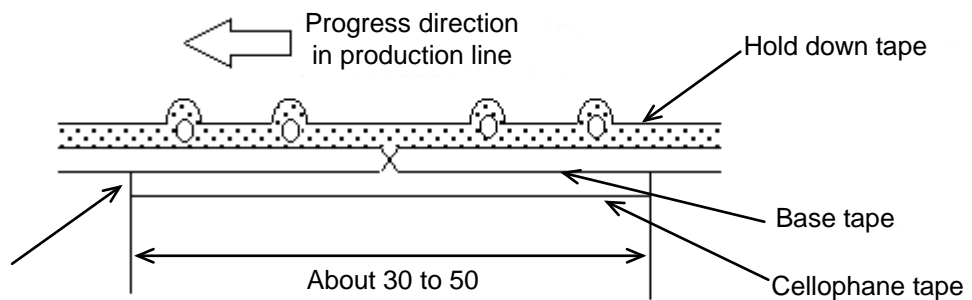
- 1) Adhesive force of tape is over 3N at test condition as below.



2) Splicing of tape

- a) When base tape is spliced

- Base tape shall be spliced by cellophane tape.
(Total tape thickness shall be less than 1.05mm.)

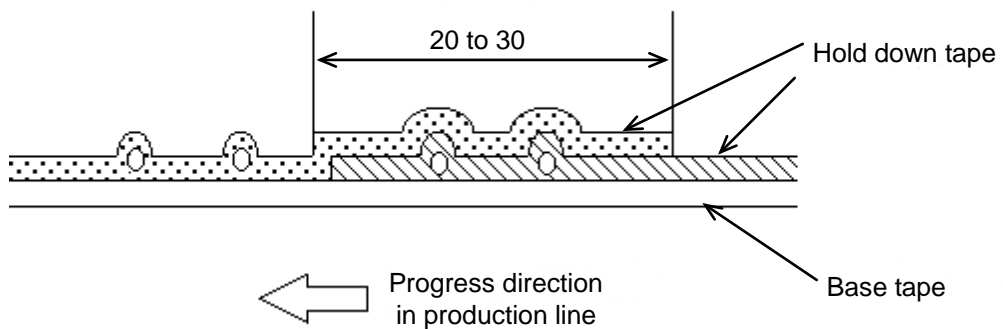


No lifting for the direction of progressing

Unit : mm

- b) When hold down tape is spliced

- Hold down tape shall be spliced with overlapping.
(Total tape thickness shall be less than 1.05mm.)



Unit : mm

- c) When both tape are spliced

- Base tape and hold down tape shall be spliced with splicing tape.

EU RoHS and Halogen Free

This products of the following crresponds to EU RoHS and Halogen Free

(1) RoHS

EU RoHs 2011/65/EC compliance

maximum concentration values tolerated by weight in homogeneous materials

- 1000 ppm maximum Lead
- 1000 ppm maximum Mercury
- 100 ppm maximum Cadmium
- 1000 ppm maximum Hexavalent chromium
- 1000 ppm maximum Polybrominated biphenyls (PBB)
- 1000 ppm maximum Polybrominated diphenyl ethers (PBDE)

(2) Halogen-Free

The International Electrochemical Commission's (IEC) Definition of Halogen-Free (IEC 61249-2-21) compliance

- 900 ppm maximum chlorine
- 900 ppm maximum bromine
- 1500 ppm maximum total chlorine and bromine